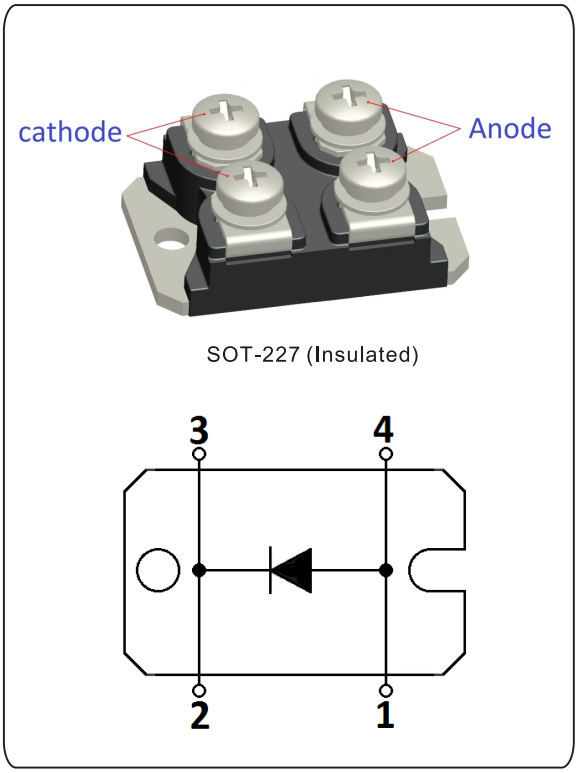
FRED
Ultrafast Soft Recovery Diode
200A / 600V

Available
RoHS*
COMPLIANT

FEATURES

- Fast recovery time characteristic
- Electrically isolated base plate
- Large creepage distance between terminal
- Simplified mechanical designs, rapid assembly
- Compliant to RoHS
- Designed and for industrial level
- Planar passivated chips



DESCRIPTION

This SOT-227 modules with FRED rectifier are available in single diode configuration. The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built.

APPLICATIONS

- Switching power supplies
- Inverters
- Motor controllers
- Converters
- Snubber diodes
- Uninterruptible power supplies (UPS)
- Induction heating
- High speed rectifiers
- Free wheeling diodes
- DC choppers

PRODUCT SUMMARY	
V_R	600 V
V_F(typical) at 125 °C	1.00 V
t_{rr} (typical)	65 ns
$I_{F(DC)}$ at T_C per diode	200A at 90 °C

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Cathode to anode voltage	V_R		600	V
Maximum continuous forward current	I_F	T_C = 90 °C	200	A
Single pulse forward current	I_{FSM}	T_J = 25 °C	2000	
RMS isolation voltage, any terminal to case	V_{ISOL}	t = 1 minute	2500	V
Maximum power dissipation	P_D	T_c = 25 °C	710	W
Operating junction and storage temperature range	T_J, T_{Stg}		- 55 to 175	°C

ELECTRICAL SPECIFICATIONS (T_J = 25 ºC unless otherwise specified)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Cathode to anode breakdown voltage	V_{BR}	I_R = 100 µA	600	-	-	V
Maximum forward voltage	V_{FM}	I_F = 200 A	-	1.20	1.45	
		I_F = 200 A, T_J = 125 ºC	-	1.00	-	
Maximum reverse leakage current	I_{RM}	V_R = V_R rated	-	0.5	5	µA
		T_J = 125°C, V_R = V_R rated	-	-	0.5	mA
Junction capacitance	C_J	V_R = 200V	400			pF

DYNAMIC RECOVERY CHARACTERISTICS PERLEG (T_J = 25 ºC unless otherwise specified)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNITS**
Reverse recovery time	t_{rr}	I_F = 0.5A, I_R = 1.0A, I_{RR} = 250mA (RG#1 CKT)		-	105	130	ns
		I_F = 1.0 A, dI_F/dt = -200 A/µs, V_R =30 V, T_J = 25°C		-	65	-	
	t_{rr1}	T_J = 25 ºC	I_F= 200A dI_F/dt = -200 A/µs V_R =200 V	-	100	-	
	t_{rr2}	T_J = 125 ºC		-	300	-	
Reverse recovery current	I_{RRM1}	T_J = 25 ºC		-	13	-	A
	I_{RRM2}	T_J = 125 ºC		-	19	-	
Reverse recovery charge	Q_{rr1}	T_J = 25 ºC		-	650	-	nC
	Q_{rr2}	T_J = 125 ºC		-	2850	-	

THERMAL - MECHANICAL SPECIFICATIONS (T_J = 25 ºC unless otherwise specified)					
PARAMETER	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Junction to case, both legs conducting per module	R_{thJC}	-	-	0.21	ºC/W (K/W)
Case to sink, flat, greased surface	R_{thCS}	-	0.05	-	
Weight		-	30	-	g
Mounting torque		-	1.3	-	Nm

Fig.1a Maximum effective transient thermal impedance, junction-to-case vs. pulse duration

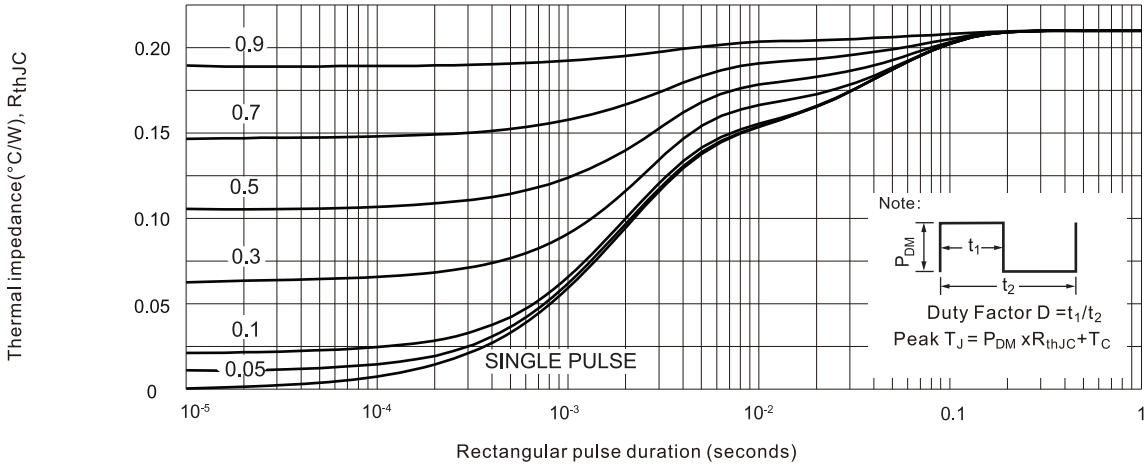


Fig.2 Forward current vs. forward voltage

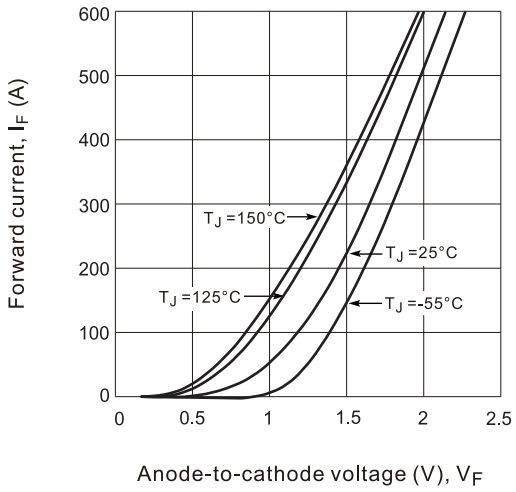


Fig.3 Reverse recovery time vs. current rate of change

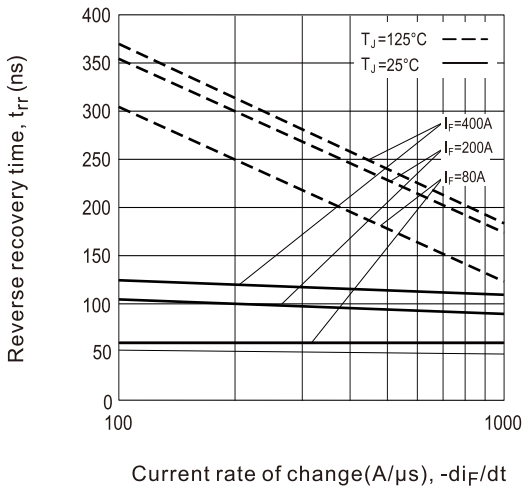


Fig.4 Reverse recovery charge vs. current rate of change

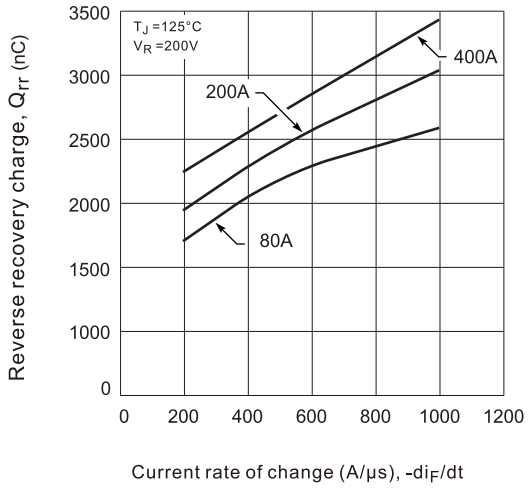


Fig 5. Reverse recovery current vs. current rate of change

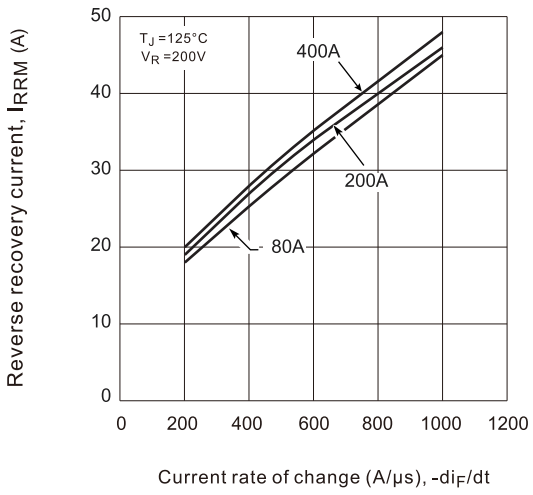


Fig.6 Maximum average forward current vs. case temperature

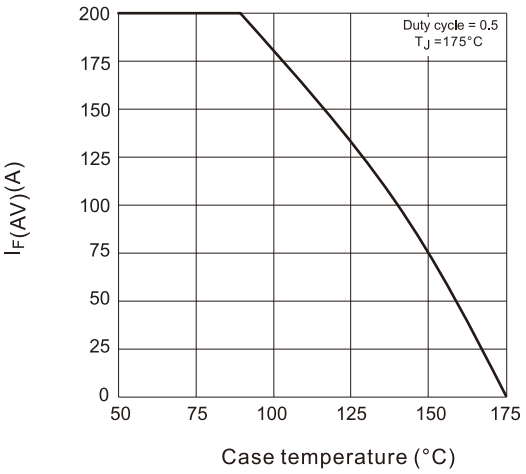


Fig.7 Junction capacitance vs. reverse voltage

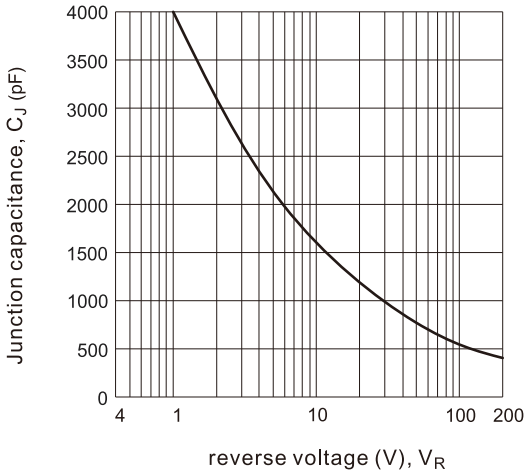


Fig.8 Reverse recovery parameter test circuit

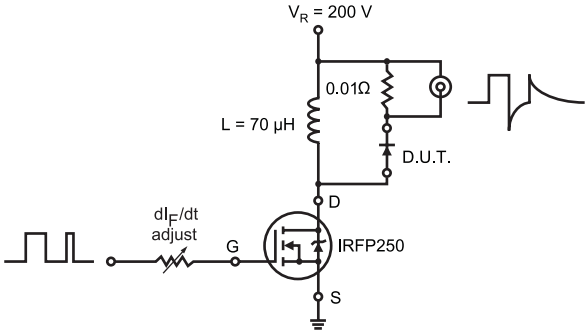
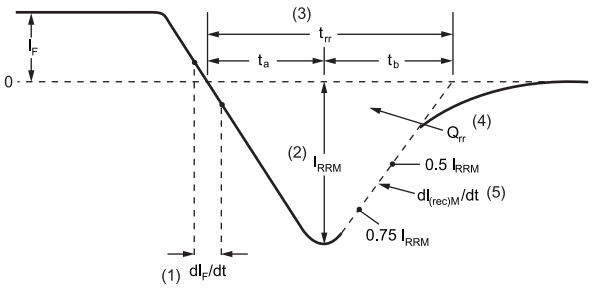


Fig.9 Reverse recovery waveform and definitions



(1) dI_F/dt - rate of change of current through zero crossing

(2) I_{RRM} - peak reverse recovery current

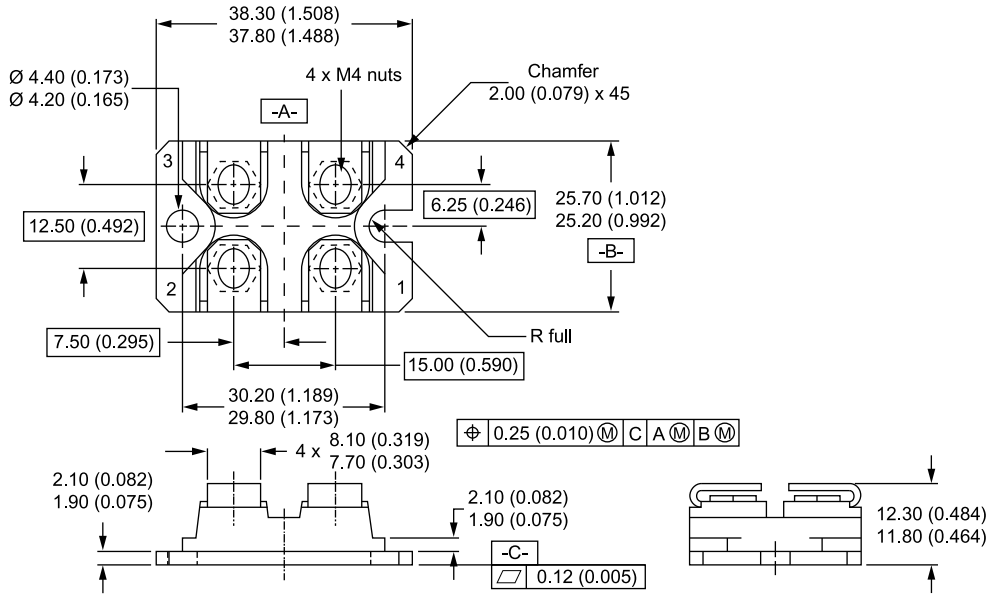
(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.

(4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

SOT-227



All dimensions in millimeters (inches)

Notes
- Dimensioning and toleranc ing per ANSI Y14.5M-1982
- Controlling dime nsion: millimeter

ORDERING INFORMATION TABLE

Device code	N	ST	200	F	06	E
	1	2	3	4	5	6

1 - Nell High Power Products
2 - Package indicator (SOT-227)
3 - Current rating (200 = 200A)
4 - F = FRED family, planar passivated chips
5 - Voltage rating (06 = 600 V)
6 - Circuit type, Single Diode insulated